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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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DATASHEET

EAHP3535YA1

Introduction

The EAHP3535 series is a surface-mount high-power device featuring high brightness combined with a compact size that is suitable for all kinds of lighting applications such as



general illumination, flash, spot, signal, industrial and commercial lighting. The thermal pad of this device is electrically isolated providing convenience in thermal and electrical design. The EAHP3535 series is one of the most promising devices in Everlight Americas high power product offering and is ready to face the challenges of today's Solid-State Lighting requirements.

Features

- ◆ LM-80 Certified
- Small package with high efficiency
- ESD protection up to 8KV
- Soldering method: SMT
- Binning Parameters: Brightness,
 Forward Voltage ,Wavelength and
 Chromaticity
- Moisture Sensitivity Level: 1
- RoHS compliant
- Matches ANSI binning

Applications

- General Lighting
- Decorative and Entertainment Lighting
- Signal and Symbol Luminaries for orientation marker lights (e.g. steps, exit ways, etc.)
- Exterior and Interior Automotive
 Illumination
- Agriculture Lighting



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Max. DC Forward Current (mA)	I _F	750 _[1]	mA
Max. Peak Pulse Current (mA)	I _{Pulse}	1000[2]	mA
Max. ESD Resistance	V_{B}	8000	V
Reverse Voltage	V _R	Note 3	V
Thermal Resistance	R _{th}	10 ~ 12 _[4]	°C/W
Max. Junction Temperature	T_J	125 _[5]	°C
Operating Temperature	T_{Opr}	-40 ~ +100 _[6]	°C
Storage Temperature	T_{Stg}	-40 ~ +100	°C
Max. Soldering Temperature	T_{Sol}	260	°C
Max. Allowable Reflow Cycles	n/a	2	cycles

Notes:

- 1. Maximum forward current for 3W is 750mA (Thermal Pad=25°C).
- 2. Duty cycle = 1/10@1KHZ
- 3. The EAHP3535 series LEDs are not designed for reverse bias use.
- Thermal Resistance is 10°C/W for Blue, Green, Cool-White, Neutral-White, and Warm-White LEDs and 12°C/W for Red, Amber, and Orange LEDs.
- Maximum junction temperature of Cool-White, Neutral-White, Warm-White, Blue, Green, Red, Amber, and Orange LEDs is 125°C.
- Maximum Operating Temperature (Thermal Pad) of Cool-White, Neutral-White, Warm-White, Blue, Green, Red, Amber, and Orange LEDs is 100°C.

JEDEC Moisture Sensitivity

Level	Floor Life			luirements ndard
Time (hours)		Conditions	Time (hours)	Conditions
1	Unlimited	≦30°C / 85% RH	168 (+5/-0)	85°C / 85% RH



PN of the EAHP3535 series: Color LEDs

Color	Order Code	Minimum Luminous Flux (lm)	Dominant Wavelength (nm)	Forward Voltage (V)
Amber	EAHP3535YA2	90	585~592.5	2.05~3.25

Note:

Each 3W direct color PN is based on the min. bin and includes four adjacent bins.



Product Binning

Luminous Flux Bins

			Lamin
Group	Bin	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)
	1	4	5
	2	5	6
	3	6	8
	4	8	10
Е	5	10	13
	6	13	17
	7	17	20
	8	20	23
	9	23	27
	1	27	33
	2	33	39
	3	39	45
	4	45	52
F	5	52	60
	6	60	70
	7	70	80
	8	80	90
	9	90	100

Group	Bin	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)
	1	100	110
	2	110	120
	3	120	130
	4	130	140
J	5	140	150
	6	150	160
	7	160	180
	8	180	200
	9	200	225
	1	225	250
	2	250	275
	3	275	300
	4	300	325
K	5	325	350
	6	350	375
	7	375	400
	8	400	425
	9	425	450
_	1	450	475
N.	2	475	500
N	3	500	525
	4	525	550

Radiometric Power Bins

Group	Bin	Minimum Radiometric Power(mW)	Maximum Radiometric Power(mW)
	1	0	25
	2	25	50
	3	50	75
	4	75	100
Q	5	100	125
	6	125	175
	7	175	225
	8	225	275
	9	275	350

Group	Bin	Minimum Radiometric Power(mW)	Maximum Radiometric Power(mW)
	1	350	425
	2	425	500
	3	500	600
	4	600	700
R	5	700	800
	6	800	900
	7	900	1000
	8	1000	1300
	9	1300	1600



Forward Voltage Bins

Bin	Minimum Forward Voltage (V)	Maximum Forward Voltage (V)
U1	1.75	2.05
U2	2.05	2.35
U3	2.35	2.65
U4	2.65	2.95
V1	2.95	3.25
V2	3.25	3.55
V3	3.55	3.85
V4	3.85	4.15

Notes:

- Forward voltage measurement tolerance: ±0.1V.
- Forward voltage bins are defined at $I_F=350$ mA operation.
- Other Forward Voltage bins for White LEDs available upon request. Please contact your local Everlight Americas sales office.

www.everlightamericas.com



Color Bins

Color Bills					
Group	Bin N	Minimum Dominant	Maximum Dominant		
		Wavelength (nm)	Wavelength (nm)		
	1	430	435		
•	2	435	440		
	3	440	445		
В	4	445	450		
(Blue)	5	450	455		
	6	455	460		
	7	460	465		
	8	465	470		
	1	520	525		
	2	525	530		
G	3	530	535		
(Green)	4	535	540		
	5	540	545		
	6	545	550		
	1	580	582.5		
Α	2	582.5	585		
(Amber)	3	585	587.5		
` ′	4	587.5	590		
	5	590	592.5		
	6	592.5	595		
R	3	610	615		
(Red)	4	615	620		
(1100)	5	620	625		
	6	625	630		
	1	635	640		
	2	640	645		
	3	645	650		
D	4	650	655		
(Deep-Red)	5	655	660		
	6	660	665		
	7	665	670		
	8	670	675		
	1	700	710		
	2	710	715		
	3	715	720		
F (5	4	720	725		
(Far-Red)	5	725	730		
	6	730	735		
	7	735	740		
	8	740	745		

- Dominant / Peak wavelength measurement tolerance: ±1nm.
- Dominant / Peak wavelength bins are defined at I_F=350 mA operation. 2.
- The range of wavelength in Royal-Blue, Deep-Red and Far-Red is described as peak-wavelength.



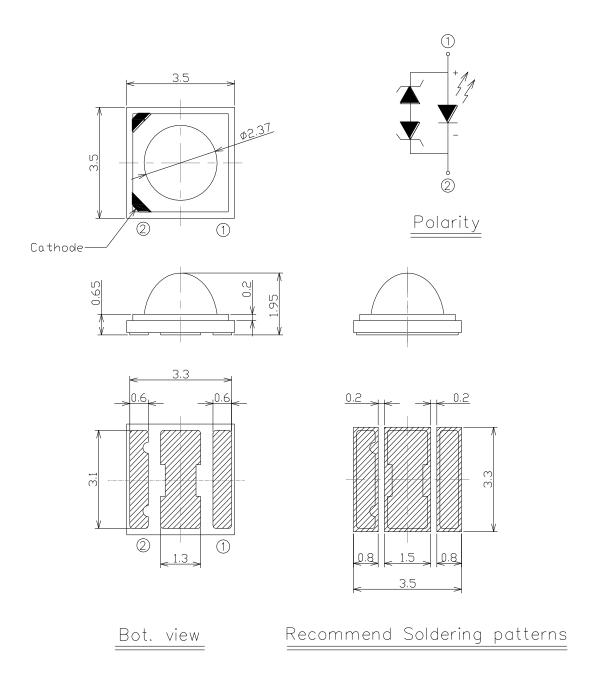
Optical Characteristics

Color	Dominant Wavelengthλ _D Peak Wavelengthλ _P Color Temperature CCT		Typical Temperature Coefficient of Dominant Wavelength (nm/°C)-(△λ _D /△	Typical Viewing Angle (degrees) 2θ _{1/2}	
	Min.	Тур.	Max.	T _J)	
Cool-White	4745K	5700K	7050K		Note 5
Neutral-White	3710K	4260K	4745K		Note 5
Warm-White	2580K	3000K	3710K		Note 5
Red	620nm		630nm	0.05	120
Orange	610nm		620nm	0.08	120
Amber	585nm		595nm	0.1	120
Green	520nm		535nm	0.05	120
Blue	460nm		470nm	0.05	120
Deep-Red	645nm		675nm	0.08	120
Far-Red	715nm		745nm	0.04	120

- 1. The test tolerance of Everlight Americas is ±0.5nm for dominant wavelength, ±5% for CCT.
- 2. Viewing angle is the width of half the light output intensity in all directions of 180°.
- All Cool-White, Neutral-White, Warm-White, and dominant wavelength below 550nm LEDs are made with Indium Gallium Nitride (InGaN).
- All LEDs with dominant wavelength exceeding 550nm are made with Aluminum Indium Gallium Phosphide (AllnGaP).



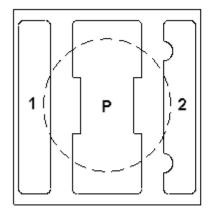
Mechanical Dimension



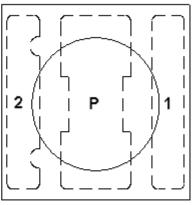
- Dimensions are in millimeters.
- Tolerances unless mentioned are ± 0.15mm.
- The thermal pad is electrically isolated from the Anode and Cathode contact pads.
- Do not handle the device by the lens. Incorrect force applied to the lens may lead to the failure of devices.



Pad Configuration







TOP VIEW

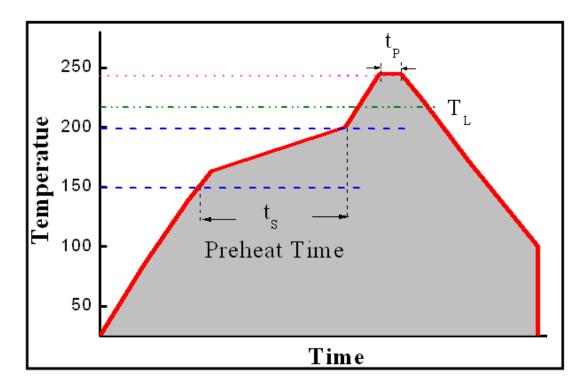
PAD	FUNCTION
1	ANODE
2	CATHODE
Р	THERMAL PAD



Reflow Soldering Characteristics

For Reflow Process

- EAHP3535 series are suitable for SMT processes.
- Curing of glue in oven must be according to standard operation flow processes.



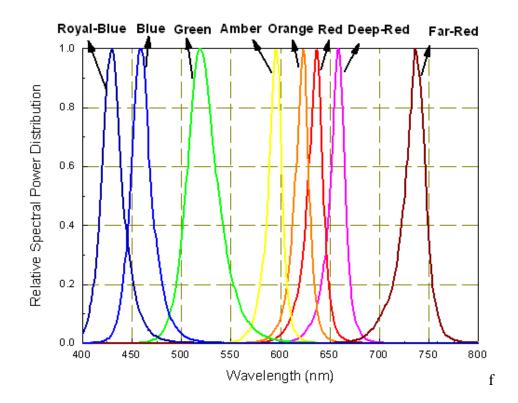
Lead Free Assembly
2-3 ℃/S
150-200 ℃
60-120 S
217 ℃
60-90 S
240 ±5 ℃
Max 20 S
3-5 ℃/S

- Reflow soldering should not be done more than twice.
- In soldering process, stress on the LEDs during heating should be avoided.
- After soldering, do not bend the circuit board.



Wavelength Characteristics

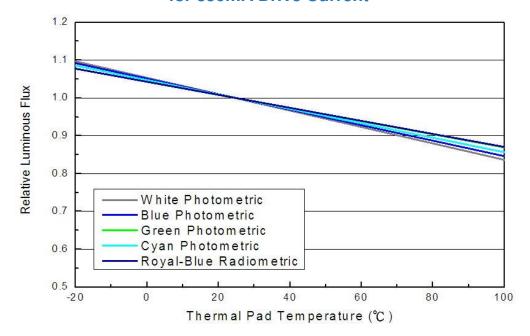
For Deep-Red, Red, Amber, Yellow, Green, Cyan, Blue, Royal-Blue @ Thermal Pad Temperature = 25°C



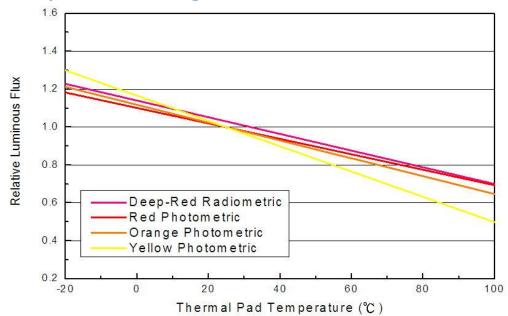


Typical Light Output Characteristic V.S. Thermal Pad Temperature

Cool-White, Neutral-White, Warm-White, Green, Cyan, Blue, Royal-Blue for 350mA Drive Current



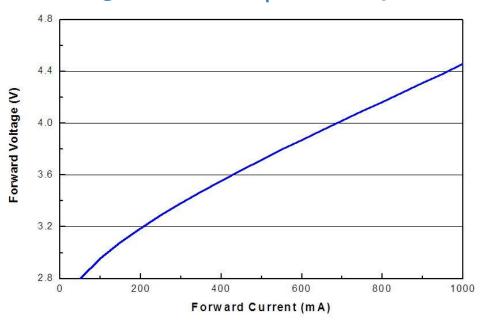
Deep-Red, Red, Orange, Amber for 350mA Drive Current



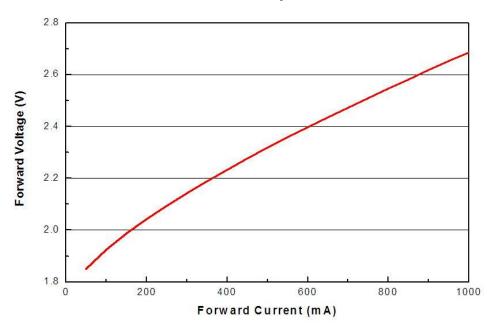


Typical Electrical Characteristics

For Cool-White, Neutral-White, Warm-White, Green, Blue @ Thermal Pad Temperature = 25°℃



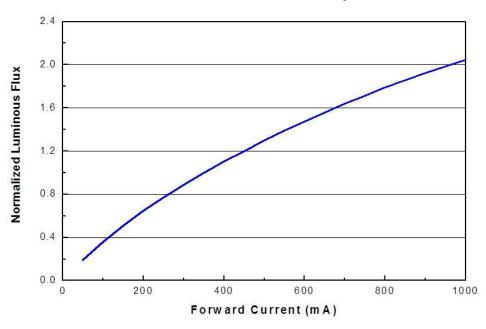
For Red, Orange, Amber, @ Thermal Pad Temperature = 25°C



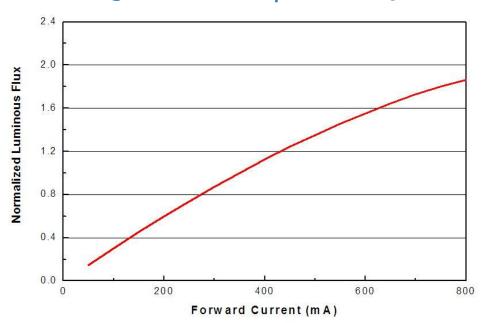


Typical Relative Luminous Flux V.S. Forward Current

For Green, Blue, @ Thermal Pad Temperature = 25°C



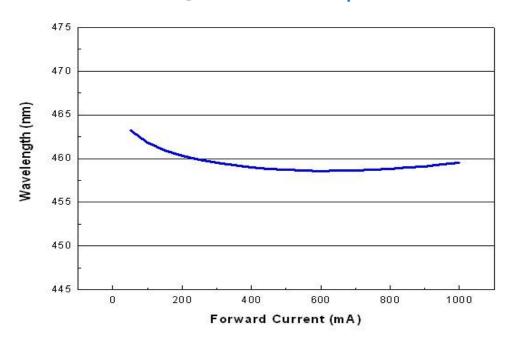
For Red, Orange, Amber, @ Thermal Pad Temperature = 25°C



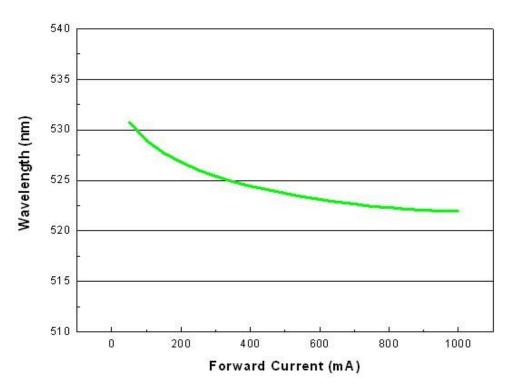


Typical Wavelength Shift Characteristics V.S. Forward Current

For Blue @ Thermal Pad Temperature = 25°℃

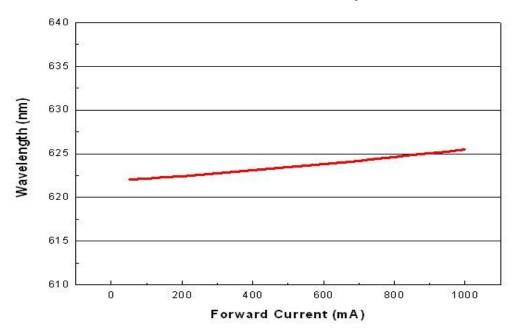


For Green @ Thermal Pad Temperature = 25°C



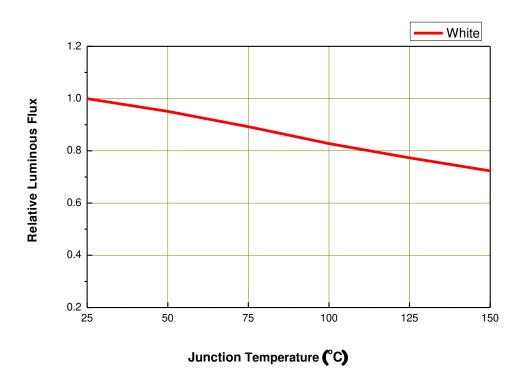


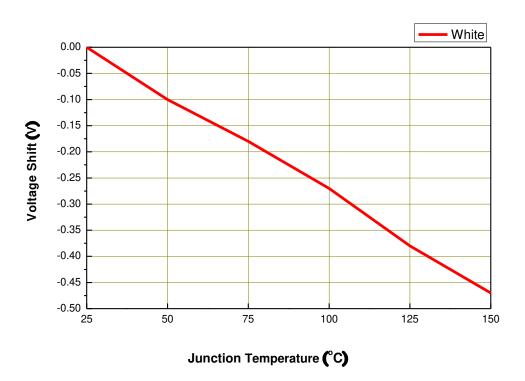
For Red @ Thermal Pad Temperature = 25°C





Relative Flux and Forward Voltage V.S. Junction Temperature (IF = 700 mA)

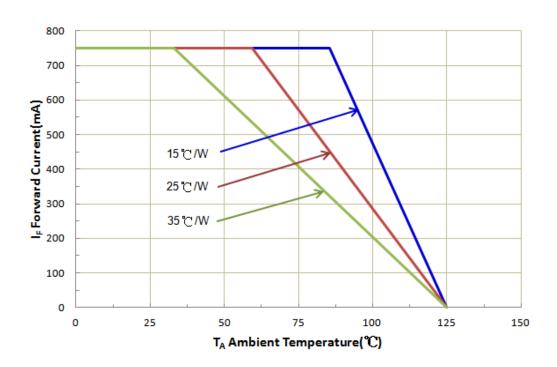






Current Derating Curves

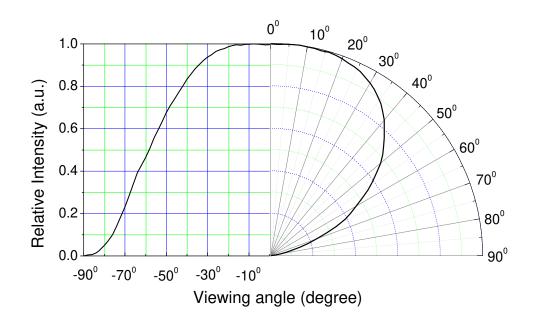
Current Derating Curve for 750mA Drive Current
Cool-White, Neutral-White, Warm-White, Green, Cyan, Blue, Royal-Blue, Far-Red,
Deep-Red, Red, Amber, Yellow





Typical Radiation Patterns

Typical Diagram Characteristics of Radiation for Cool-White, Neutral-White, Warm-White



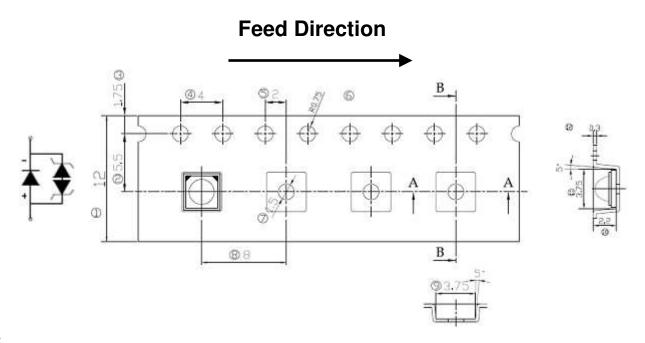
- 1. 20_{1/2} is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
- 2. View angle tolerance is $\pm 5^{\circ}$.



Emitter Tape Packaging

Carrier Tape Dimensions as the following:

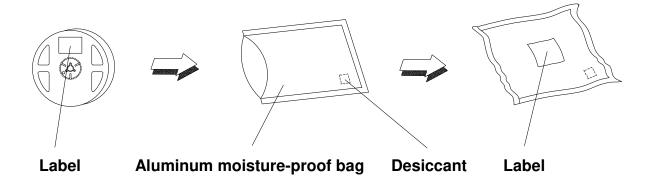
Reel: 400pcs, MOQ≥ 2Kpcs(has to be a multiple of 400pcs)



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ±0.1mm.

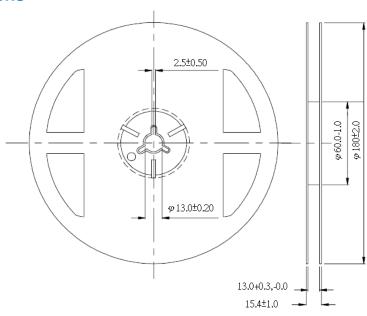
Moisture Resistant Packaging





Emitter Reel Packaging

Reel Dimensions



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances unless mentioned are ±0.1mm.

Product Labeling

Label Explanation

CPN: Customer Specification (when required)

P/N: Everlight Americas Production Number

QTY: Packing Quantity

CAT: Luminous Flux (Brightness) Bin

HUE: Color Bin

REF: Forward Voltage Bin

LOT No: Lot Number

MADE IN TAIWAN: Production Place





Storage Conditions

- Before the package is opened. The LEDs should be stored at 30°C or less and 85%RH or less after being shipped from Everlight Americas and the storage life limits are 1 year. The LEDs can be stored up to 3 years If in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- After opening the package: The LED's floor life is 1 year under 30°C or less and 60%RH or less. The LED should be soldered with 168hrs (7days) after opening the package. If unused LEDs remain, it should be stored in moisture proof packages.
- If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5°C for 24 hours.

DATASHEET
SMD • HP
EAHP3535 Series



Revision History

Current version: 2014/07/03 Device No: DHE-000XXXX

Version. 1

Page	Subjects (major change in previous version)	Date of change